

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10559684			
<b>Filing Date:</b>	06-Dec-2005			
<b>Title of Invention:</b>	Adhesive sheet, dicing tape intergrated type adhesive sheet, and semiconductor device producing method			
First Named Inventor/Applicant Name:	Teiichi Inada			
<b>Filer:</b>	William Ivan Solomon/Kelli Harris			
<b>Attorney Docket Number:</b>	1204.45675X00			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 3 months with \$0 paid	1253	1	1020	1020

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Processing Fee, except for Provis. apps	1808	1	130	130
<b>Total in USD (\$)</b>				<b>1150</b>